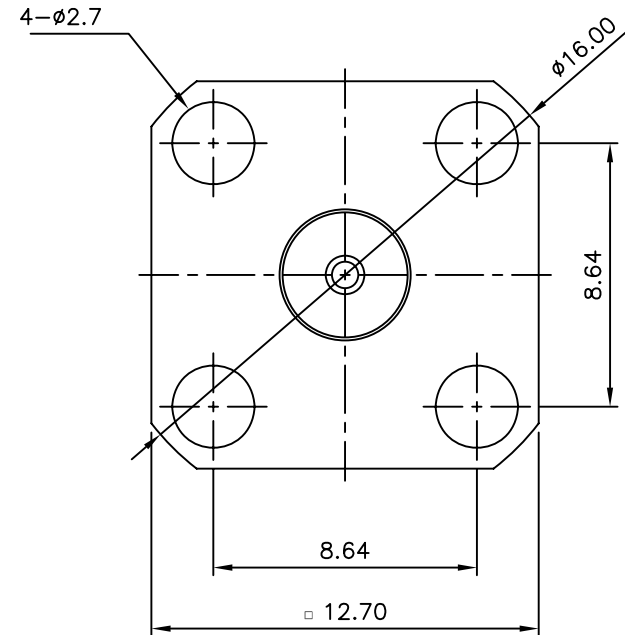
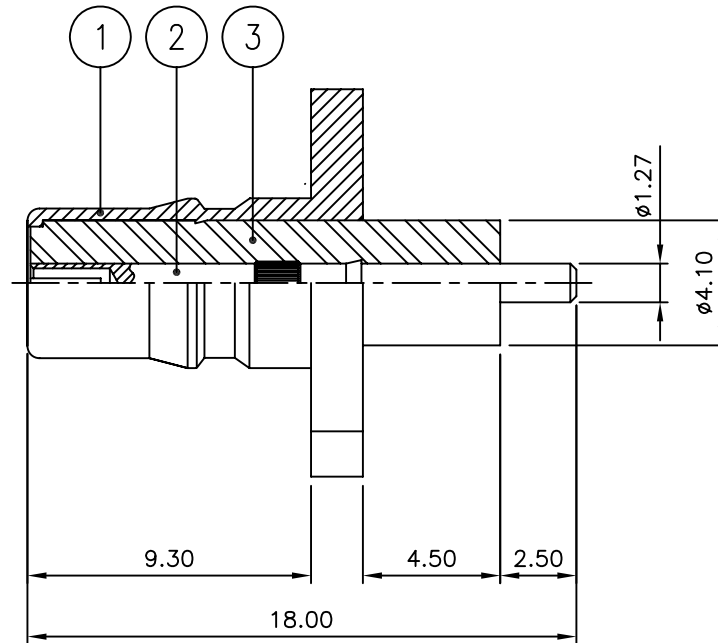


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.03.20.
1	[설번No.201504-0006] BODY 표준화 치수 변경	H.J.LEE	I.C.KIM	2015.04.17.
2	[설번No.201806-0002] QMA 표준화 치수 변경	S.Y.EUN	I.C.KIM	2018.06.11.



* ELECTRICAL SPECIFICATIONS
Frequency Range : DC~3GHz
Impedance : 50Ω(Nominal)
PIMD : 145dBc @ 27dBm

2 1		3	INSULATOR	1	TEFLON		DIN02359-N/1
		2	CONTACT	1	BeCu	Silver 3.0μm min.	DCT02803-5/2
		1	BODY	1	MBsBD	SUCO 3.0μm min.	DBD03597-5/2
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
Decimal ±0.1		DATE 2018. 06. 11.			KJ  COMTECH KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
Angle ±1°	APPROVED BY	I.C.KIM					
	CHECKED BY						
	DRAWN BY	S.Y.EUN		TITLE KQMA50 SOLDER END JS-4H			
	SCALE 4/1	UNIT mm			A4	DWG NO. CN03194-7/2	
					REVISION 2	SHEET 1 of 1	